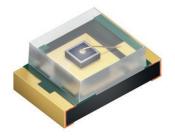
# **OSRAM** SFH 2770 A01 **Datasheet**



# Chip LED 0805

# SFH 2770 A01

High Precision Ambient Light Photodiode





## **Applications**

- Ambient Light Sensing

- Rain, Light & Tunnel Sensing

#### **Features**

- Package: clear epoxy
- Qualifications: AEC-Q102 Qualified
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)
- Nearly perfect match with Human Eye Sensitivity (V,)
- Very small SMT package
- SMT package 0805, colorless clear resin, 2 mm x 1.25 mm x 0.8 mm
- Low leakage current



# **Ordering Information**

Туре	Photocurrent 1)	Photocurrent	Ordering Code
		typ.	
	e	$E_e = 0.01 \text{ mW/cm}^2$ ; $\lambda = 560 \text{ nm}$ ; $V_R = 1$	V
	V <sub>R</sub> = 1 V		
	I <sub>P</sub>	I <sub>P</sub>	
SFH 2770 A01	≥ 4.8 nA	6.2 nA	Q65113A2349

Note: corresponds to an illuminance of app. 55 lx



Maximum Ratings				
Parameter	Symbol		Values	
Operating Temperature	T <sub>op</sub>	min.	-40 °C	
	Gp.	max.	100 °C	
Storage temperature	T <sub>stg</sub>	min.	-40 °C	
	3.9	max.	100 °C	
Reverse voltage	$V_R$	max.	2 V	
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	$V_{ESD}$	max.	2 kV	



## **Characteristics**

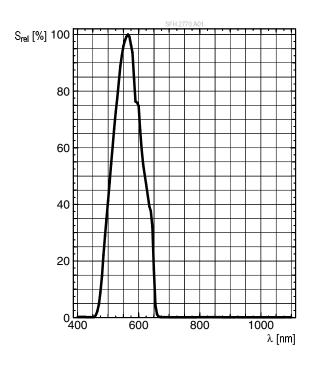
T<sub>A</sub> = 25 °C

Parameter	Symbol		Values
Recommended operating range for illuminance	E <sub>v</sub>	typ.	5 100000 lx
Wavelength of max sensitivity	$\lambda_{_{ extsf{S max}}}$	typ.	565 nm
Spectral range of sensitivity	λ <sub>10%</sub>	typ.	480 650 nm
Photocurrent $E_v = 1000 \text{ lx}$ ; Std. Light A; $V_R = 1 \text{ V}$	I <sub>P</sub>	typ.	0.1 μΑ
Radiant sensitive area	А	typ.	0.16 mm²
Dimensions of active chip area	LxW	typ.	0.4 x 0.4 mm x mm
Half angle	φ	typ.	68 °
Dark current $V_R = 1 V; E = 0$	I <sub>R</sub>	typ. max.	0.005 nA 0.15 nA
Rise time $V_R = 1 \text{ V}; R_L = 1 \text{ k}\Omega; \lambda = 530 \text{ nm}; I_P = 4 \mu\text{A}$	t,	typ.	400 ns
Fall time $V_R = 1 \text{ V}; R_L = 1 \text{ k}\Omega; \lambda = 530 \text{ nm}; I_P = 4 \mu\text{A}$	t <sub>f</sub>	typ.	400 ns
Capacitance $V_R = 0 \text{ V}; f = 1 \text{ MHz}; E = 0$	C <sub>0</sub>	typ.	42 pF



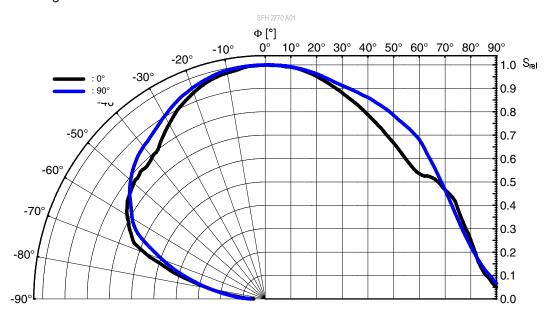
# Relative Spectral Sensitivity 2), 3)

 $S_{rel} = f(\lambda)$ 



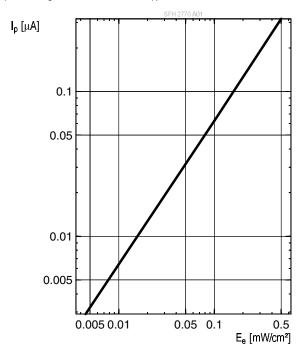
### Directional Characteristics 2), 3)

 $S_{rel} = f(\phi)$ ;  $0^{\circ} = long axis/ <math>90^{\circ} = short axis$ 



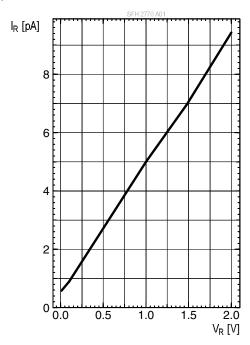
### Photocurrent 2), 3)

$$I_{P} = f(E_{e}); \lambda = 560 \text{ nm}; V_{R} = 1 \text{ V}$$



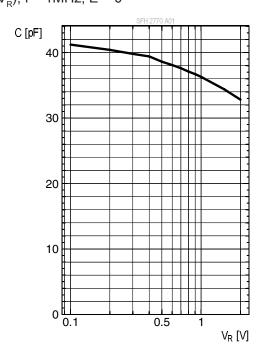
### Dark Current 2), 3)

$$I_{R} = f(V_{R}); E = 0$$



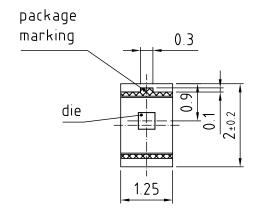
# Capacitance 2), 3)

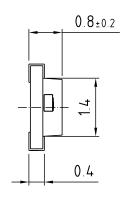
$$C = f(V_R); f = 1MHz; E = 0$$

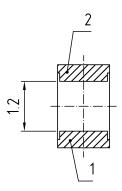




# Dimensional Drawing 4)







general tolerance  $\pm$  0.1 lead finish Au

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### **Further Information:**

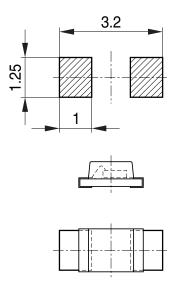
**Approximate Weight:** 4.0 mg

Package marking: Cathode

Pin	Description
1	Anode
2	Cathode



# Recommended Solder Pad 4)

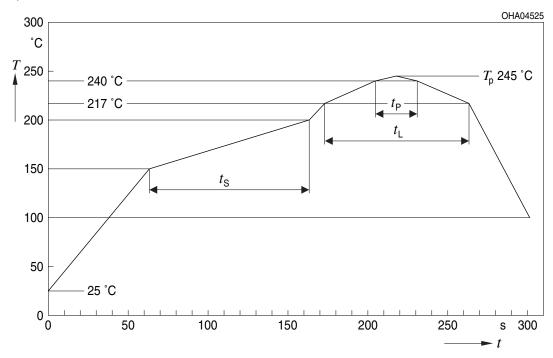


Bauteil positioniert Component location on pad OHFP2578



## **Reflow Soldering Profile**

Product complies to MSL Level 3 acc. to JEDEC J-STD-020E



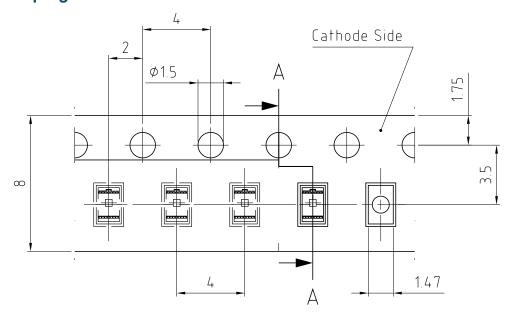
Profile Feature	Symbol Pb-Free (SnAgCu) Assembly			sembly	Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time $t_s$ $T_{smin}$ to $T_{smax}$	t <sub>s</sub>	60	100	120	S
Ramp-up rate to peak*) $T_{Smax}$ to $T_{P}$			2	3	K/s
Liquidus temperature	$T_{L}$		217		°C
Time above liquidus temperature	$t_{\scriptscriptstyle \! \! \! \! \! \! \! \! \! \! \! \! \! \! \! \! \! \! \!$		80	100	S
Peak temperature	T <sub>P</sub>		245	260	°C
Time within 5 °C of the specified peak temperature T <sub>P</sub> - 5 K	t <sub>P</sub>	10	20	30	S
Ramp-down rate* T <sub>p</sub> to 100 °C			3	6	K/s
Time 25 °C to T <sub>P</sub>				480	S

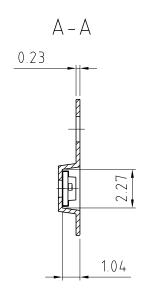
All temperatures refer to the center of the package, measured on the top of the component

<sup>\*</sup> slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range



# Taping 4)

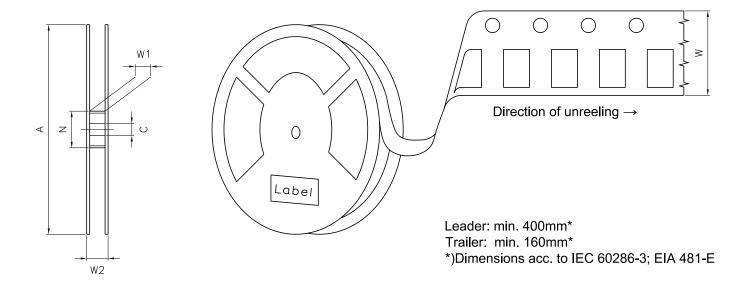




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## Tape and Reel 5)



### **Reel Dimensions**

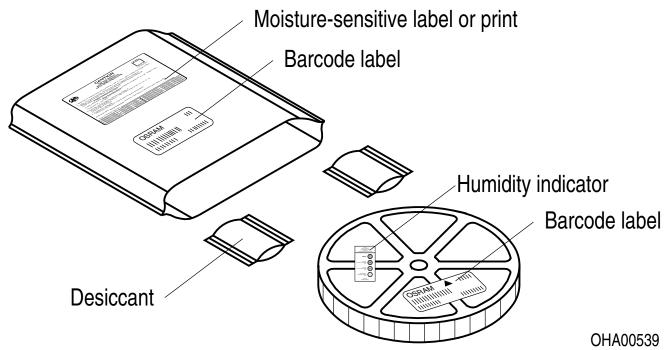
Α	W	$N_{\min}$	$W_1$	$W_{2 max}$	Pieces per PU
180 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	3000



#### **Barcode-Product-Label (BPL)**



## Dry Packing Process and Materials 4)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

SFH 2770 A01 **DATASHEET** 



#### **Notes**

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit https://ams-osram.com/support/application-notes



#### Disclaimer

#### Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

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#### **Packing**

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

#### Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.



#### **Glossary**

- Photocurrent: The photocurrent values are measured (by irradiating the devices with a homogenous light source and applying a voltage to the device) with a tolerance of ±11 %.
- 2) Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 3) **Testing temperature:** TA = 25°C (unless otherwise specified)
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- 5) Tape and Reel: All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



## **Revision History**

Version	Date	Change
1.0	2021-07-06	Initial Version
1.1	2021-10-01	Brand
1.2	2023-03-31	Taping New Layout Applications
1.3	2024-03-14	Characteristics Electro - Optical Characteristics (Diagrams)



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